

Line Number	Hits	Search Text	DB	Time stamp
1	1	8948969.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:25
7	1	8948969.pn. and frame	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:25
13	1	8948969.pn. and support	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:26
19	0	8948969.pn. and joint frit	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:27
25	1	8948969.pn. and ledge	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 11:27
31	13	ando-yoichi.in. and emitter	USPAT; US-PGPUB; EPO; JPO; DEPENT; IBM_TDB	2003/07/17 11:47
38	5	ando-yoichi.in. and emitter and (surround\$4 encirc1\$4 circ1\$4)	USPAT; US-PGPUB; EPO; JPO; DEPENT; IBM_TDB	2003/07/17 11:47
45	5	ando-yoichi.in. and emitter and (surround\$4 encirc1\$4 circ1\$4)	USPAT; US-PGPUB; EPO; JPO; DEPENT; IBM_TDB	2003/07/17 11:50
52	8	(ando-yoichi.in. and emitter) not (ando-yoichi.in. and emitter and (surround\$4 encirc1\$4 circ1\$4))	USPAT; US-PGPUB; EPO; JPO; DEPENT; IBM_TDB	2003/07/17 11:50
141	1	6509691.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:12
147	0	6509691.pn. and (surround\$5).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:12
153	0	6509691.pn. and (encirc1\$4 circ1\$4).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
165	1	20030102798.did. and (surround\$4 encirc1\$4 circ1\$4).clm.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
169	1	20030102798.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
171	1	20030102798.did. and surround\$4	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:14
177	1	20030102798.did. and apart from	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/17 12:19

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-	200	313 496).CCLS. not 313 495).CCLS.	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:40
-	2	5903108.pn.	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:06
-	0	516788.URFN.	USPAT	2003/01/31 11:40
-	162	pixtech.as.	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:01
-	299279	5903108.pn. spacer	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:06
-	1	5903108.pn. and spacer	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:16
-	0	5463276.pn. and image	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:16
-	4	5463276.pn. 4899081.pn. 5270613.pn. and image	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:17
-	1	(5463276.pn. 4899081.pn. 5270613.pn.) and image	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:17
-	1105	((313/496) or (313/495)).CCLS.	USPAT; US-PGPUB	2003/01/31 11:28
-	755	(313/493).CCLS.	USPAT; US-PGPUB	2003/01/31 11:28
-	0	("198 not 195").FN.	USPAT; US-PGPUB	2003/01/31 11:28
-	729	((313/493).CCLS.) not (((313/496) or (313/495)).CCLS.)	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:30
-	193	((313/493).CCLS.) not ((313/496) or (313/495)).CCLS.) and display	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:30
-	80	((313/493).CCLS.) not 313 496) or (313 495).CCLS. and display and image	USPAT; US-PGPUB; EPO; JPO; DEFWENT; IBM_TDB	2003/01/31 11:37
-	939	313 634).CCLS.	USPAT; US-PGPUB	2003/01/31 11:43
-	5	("5508584" "5543691" "5561345" "55614751" "5567006").FN.	USPAT	2003/01/31 11:37
-	1	5903108.URFN.	USPAT	2003/01/31 11:47
-	1434	313 493 or 313 495 or 313 496).CCLS.	USPAT; US-PGPUB	2003/01/31 11:43
-	0	"1125 not 1133").FN.	USPAT; US-PGPUB	2003/01/31 11:43

-	725	313-634 .CCLS. not 313-493 or 313-496 or 313-497 .CCLS.	USPAT; US-PGPUB; EPO; JPO; EPO; JPO; EPO; JPO; IBM_TDB	2003/07/16 11:43
-	46	313-634 .CCLS. not 313-493 or 313-496 or 313-497 .CCLS. and image and forming display	USPAT; US-PGPUB; EPO; JPO; EPO; JPO; IBM_TDB	2003/07/16 11:43
-	1706	313-496 or 313-496 or 313-493 .CCLS.	USPAT	2003/07/16 15:25
-	211	313-496 or 313-496 or 313-493 .CCLS.	US-PGPUB	2003/07/16 15:14
-	1	5770918.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:26
-	1	5770918.pn. and 403b	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:31
-	1	6114604.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:31
-	1	6114604.pn. and "14"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:40
-	1	20020005692.did.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:19
-	0	20020005692.did. and conductive adj layer	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:40
-	1	20020005692.did. and conductive adj film	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:43
-	1	20020005692.did. and conductive adj film near4 "5"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:58
-	1	5903108.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:47
-	1	5903108.pn. and spacer	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 15:47
-	1	20020005692.did. and conductive adj film near4 "14"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:15
-	1	5903108.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:15
-	1	5903108.pn. and track	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:18
-	1	5903108.pn. and track rim: with material	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:18

-	1	20020005690.did. and 27P	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:33
-	1	20020005690.did. and longitudinal	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:34
-	1	20020005690.did. and longitudinal with end same discharge	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:35
-	1	20020005690.did. and longitudinal with end same suppressing	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 16:36
-	1	20020005690.did. and longitudinal with end	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:06
-	1	20020005690.did. and conductive adj film with "8" same surface	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:19
-	1	5903108.pn. and spacer	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:23
-	1	5903108.pn. and (ring track) same (film coat\$ layer\$4)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:30
-	0	5903108.pn. and (closed adj loop)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:34
-	1	5903108.pn. and bias\$4	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:34
-	1	5903108.pn. and bias\$4 same (track ring)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 17:36
-	1	5903108.pn. and bias\$4 same (track ring) same cathode	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:06
-	79	jones-gary-w.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:07
-	34	jones-gary-w.in. and zimmerman-steven-m.in.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:07
-	1	6169358.pn.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:07
-	1	6169358.pn. and "340"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:18
-	1	20020005690.did. and "14"	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 18:18

-	1	20030716\$P1.dia. and surround\$5; conductive adj film	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:18
-	1	59031.6.UMPN.	USPAT	2003/07/16 19:18
-	11-4	anode same surround ring encircle circle and image display panel	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:19
-	17	surround\$5 ring encircle circle\$4 with image with display panel same conducting conductive metallic near3 (film coat layer) and substrate	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:19
-	17	surround\$5 ring encircle circle\$4 with image with display panel same conducting conductive metallic near3 (film coat layer) and substrate	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:19
-	17	((surround\$5 ring encircle circle\$4) with image with display panel same conducting conductive metallic near3 (film coat layer) and substrate and surround\$5 ring encircle circle\$4 with image with display panel same conducting conductive metallic near3 (film coat layer)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:19
-	262	surround\$5 ring encircle circle\$4 with anode electrode same conducting conductive metallic near3 (film coat layer) and substrate and image and display panel image.ab,ti.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:17
-	60	surround\$5 ring encircle circle\$4 near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and substrate and image and display panel image.ab,ti. not (((surround\$5 ring encircle circle\$4) with image with display panel) same (conducting conductive metallic) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circle\$4) with image with display panel) same (conducting conductive metallic) near3 (film coat layer)	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:20
-	60	surround\$5 ring encircle circle\$4 near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and ((surround\$5 ring encircle circle\$4) near4 (phosphor anode electrode) with (conducting conductive metallic) near3 (film coat layer) and substrate and image and display panel image.ab,ti. not ((surround\$5 ring encircle circle\$4) with image with display panel) same conducting conductive metallic near3 film coat layer) and substrate) and (surround\$5 ring encircle circle\$4) with image with display panel) same conducting conductive metallic near3 film coat layer	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:21

-	13	((surround\$5 ring encircle circle\$4 near4 phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and ((surround\$5 ring encircle circle\$4 near4 phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not ((surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic metal) near3 (film coat layer) and substrate and (surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic metal) near3 (film coat layer))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:13
-	14	((surround\$5 ring encircle circle\$4 near4 phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not ((surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic metal) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic metal) near3 (film coat layer))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:24
-	14	((surround\$5 ring encircle circle\$4 near4 phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not ((surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic metal) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic metal) near3 (film coat layer))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:25
-	14	((surround\$5 ring encircle circle\$4 near4 phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and ((surround\$5 ring encircle circle\$4 near4 phosphor anode (electrode near4 phosphor)) with (conducting conductive metallic metal) near3 (film coat layer) and substrate and image and (display panel image).ab,ti. not ((surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic metal) near3 (film coat layer) and substrate) and (surround\$5 ring encircle circle\$4 with (image with (display panel)) same (conducting conductive metallic metal) near3 (film coat layer))	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:46
-	22	guard adj ring near6 anode	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:47
-	23	guard adj ring near6 anode and image and (display panel).ab,ti.	USPAT; US-PGPUB; EPO; JPO; IBM_TDB	2003/07/16 19:47

guard adj ring near13 and image and  
display panel .ab,ti.

USPAT;  
US-IPRIB;  
EP; JPD;  
IBM\_TIB

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